

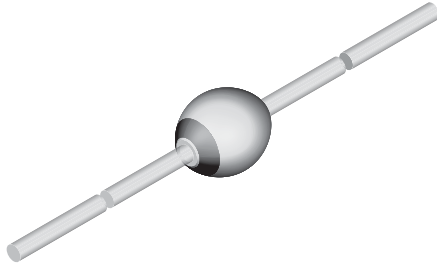


THE DATASHEET OF SF4005-TAP





Ultra-Fast Avalanche Sinterglass Diode



949539

DESIGN SUPPORT TOOLS

[click logo to get started](#)



FEATURES

- Glass passivated
- Hermetically sealed axial leaded glass envelope
- Low reverse current
- High reverse voltage
- Material categorization:
for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

APPLICATIONS

- Switched mode power supplies
- High-frequency inverter circuits

MECHANICAL DATA

Case: SOD-57

Terminals: plated axial leads, solderable per MIL-STD-750, method 2026

Polarity: color band denotes cathode end

Mounting position: any

Weight: approx. 369 mg

ORDERING INFORMATION (Example)			
DEVICE NAME	ORDERING CODE	TAPED UNITS	MINIMUM ORDER QUANTITY
SF4007	SF4007-TR	5000 per 10" tape and reel	25 000
SF4007	SF4007-TAP	5000 per ammpack	25 000

PARTS TABLE		
PART	TYPE DIFFERENTIATION	PACKAGE
SF4001	$V_R = 50\text{ V}; I_{F(AV)} = 1\text{ A}$	SOD-57
SF4002	$V_R = 100\text{ V}; I_{F(AV)} = 1\text{ A}$	SOD-57
SF4003	$V_R = 200\text{ V}; I_{F(AV)} = 1\text{ A}$	SOD-57
SF4004	$V_R = 400\text{ V}; I_{F(AV)} = 1\text{ A}$	SOD-57
SF4005	$V_R = 600\text{ V}; I_{F(AV)} = 1\text{ A}$	SOD-57
SF4006	$V_R = 800\text{ V}; I_{F(AV)} = 1\text{ A}$	SOD-57
SF4007	$V_R = 1000\text{ V}; I_{F(AV)} = 1\text{ A}$	SOD-57

ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25\text{ }^\circ\text{C}$, unless otherwise specified)					
PARAMETER	TEST CONDITION	PART	SYMBOL	VALUE	UNIT
Reverse voltage = repetitive peak reverse voltage	See electrical characteristics	SF4001	$V_R = V_{RRM}$	50	V
		SF4002	$V_R = V_{RRM}$	100	V
		SF4003	$V_R = V_{RRM}$	200	V
		SF4004	$V_R = V_{RRM}$	400	V
		SF4005	$V_R = V_{RRM}$	600	V
		SF4006	$V_R = V_{RRM}$	800	V
		SF4007	$V_R = V_{RRM}$	1000	V
Peak forward surge current	$t_p = 10\text{ ms}$, half sine wave		I_{FSM}	30	A
Average forward current	Lead length $l = 10\text{ mm}$		I_{FAV}	1	A
Junction and storage temperature range			$T_j = T_{stg}$	-55 to +175	$^\circ\text{C}$
Non repetitive reverse avalanche energy	$I_{(BR)R} = 0.4\text{ A}$		E_R	10	mJ



MAXIMUM THERMAL RESISTANCE ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Junction ambient	Lead length $l = 10\text{ mm}$, $T_L = \text{constant}$	R_{thJA}	45	K/W
	On PC board with spacing 25 mm	R_{thJA}	100	K/W

ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	$I_F = 1\text{ A}$	SF4001	V_F	-	-	1	V
		SF4002	V_F	-	-	1	V
		SF4003	V_F	-	-	1	V
		SF4004	V_F	-	-	1	V
		SF4005	V_F	-	-	1.7	V
		SF4006	V_F	-	-	1.7	V
		SF4007	V_F	-	-	1.7	V
Reverse current	$V_R = V_{RRM}$		I_R	-	-	5	μA
	$V_R = V_{RRM}$, $T_j = 125\text{ }^{\circ}\text{C}$		I_R	-	-	50	μA
Reverse breakdown voltage	$I_R = 100\text{ }\mu\text{A}$	SF4001	$V_{(BR)R}$	50	-	-	V
		SF4002	$V_{(BR)R}$	100	-	-	V
		SF4003	$V_{(BR)R}$	200	-	-	V
		SF4004	$V_{(BR)R}$	400	-	-	V
		SF4005	$V_{(BR)R}$	600	-	-	V
		SF4006	$V_{(BR)R}$	800	-	-	V
		SF4007	$V_{(BR)R}$	1000	-	-	V
Reverse recovery time	$I_F = 0.5\text{ A}$, $I_R = 1\text{ A}$, $i_R = 0.25\text{ A}$	SF4001	t_{rr}	-	-	50	ns
		SF4002	t_{rr}	-	-	50	ns
		SF4003	t_{rr}	-	-	50	ns
		SF4004	t_{rr}	-	-	50	ns
		SF4005	t_{rr}	-	-	75	ns
		SF4006	t_{rr}	-	-	75	ns
		SF4007	t_{rr}	-	-	75	ns

TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

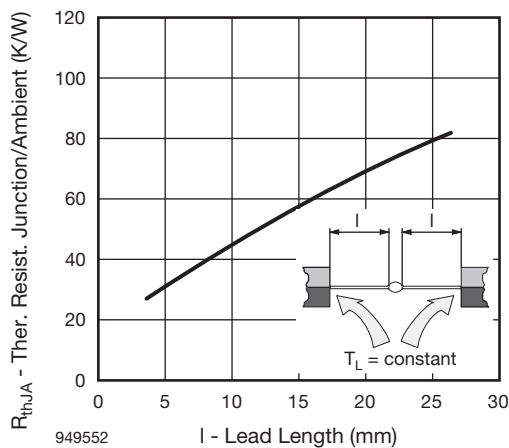


Fig. 1 - Max. Thermal Resistance vs. Lead Length

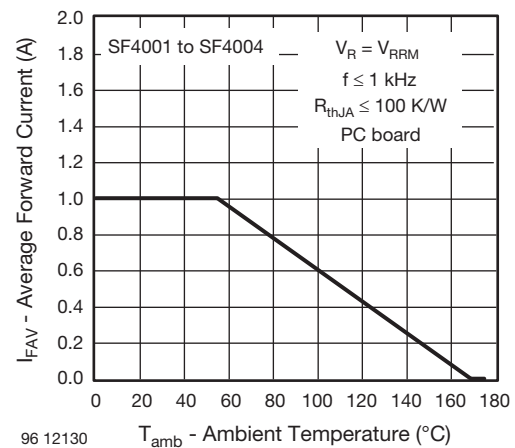


Fig. 2 - Max. Average Forward Current vs. Ambient Temperature

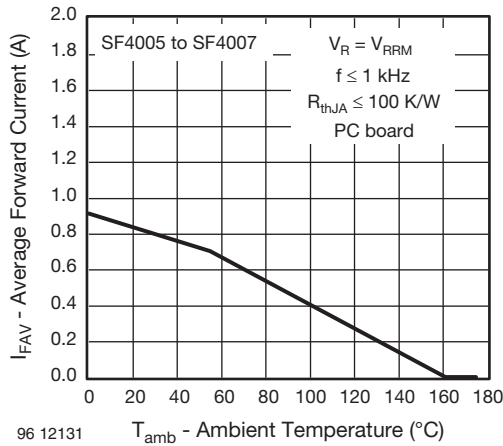


Fig. 3 - Max. Average Forward Current vs. Ambient Temperature

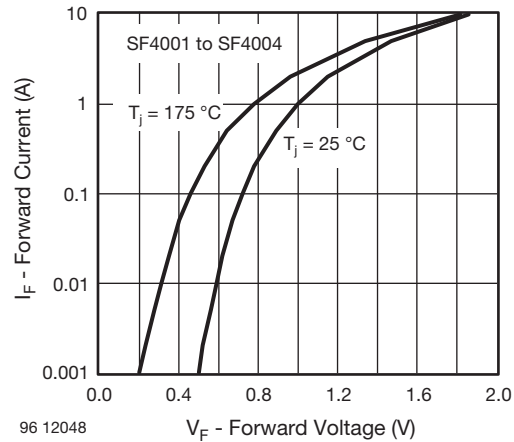


Fig. 6 - Max. Forward Current vs. Forward Voltage

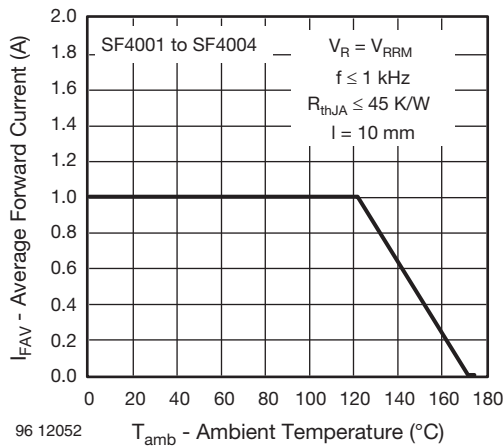


Fig. 4 - Max. Average Forward Current vs. Ambient Temperature

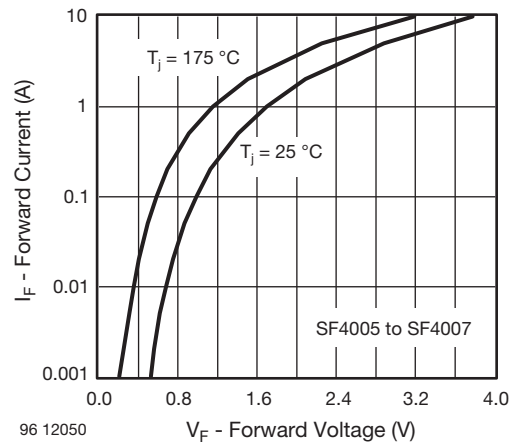


Fig. 7 - Max. Forward Current vs. Forward Voltage

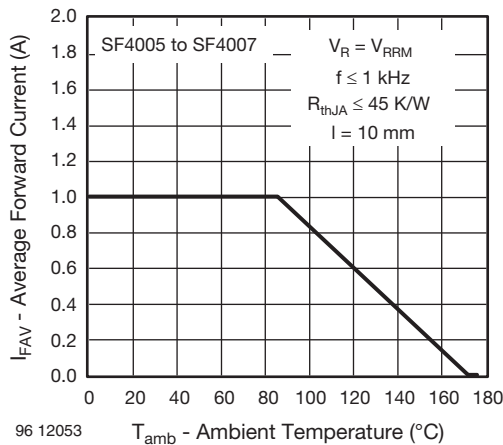


Fig. 5 - Max. Average Forward Current vs. Ambient Temperature

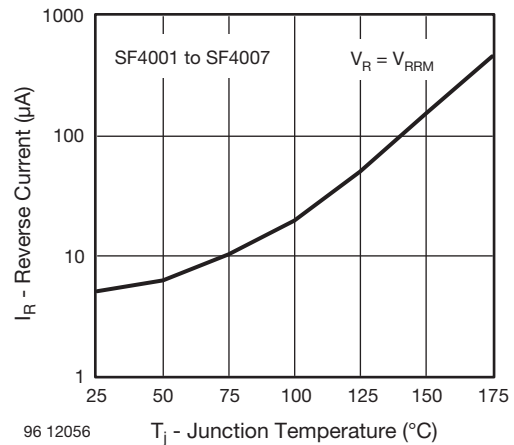


Fig. 8 - Max. Reverse Current vs. Junction Temperature

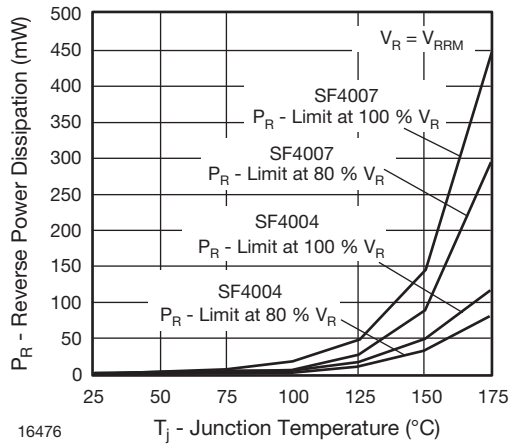


Fig. 9 - Max. Reverse Power Dissipation vs. Junction Temperature

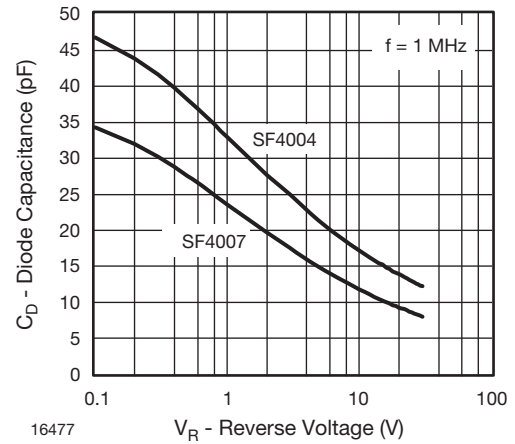
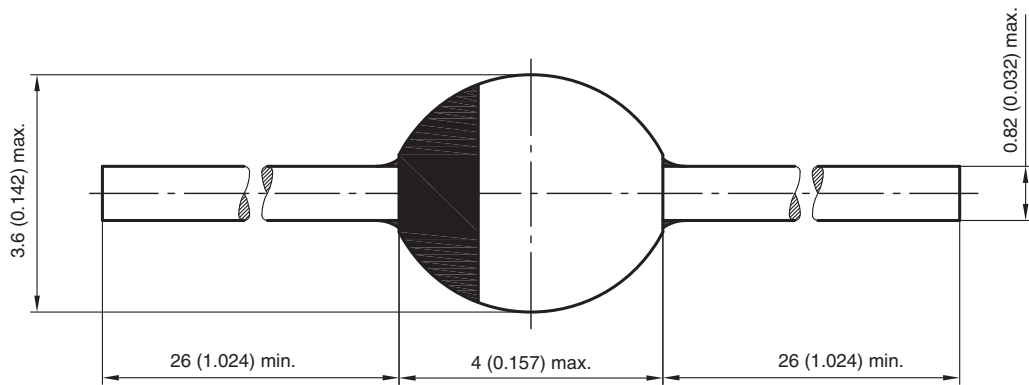


Fig. 10 - Diode Capacitance vs. Reverse Voltage

PACKAGE DIMENSIONS in millimeters (inches): **SOD-57**



20543
Rev. 3 - Date: 09.February 2005
Document no.:6.563-5006.3-4



Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Vishay products are not designed for use in life-saving or life-sustaining applications or any application in which the failure of the Vishay product could result in personal injury or death unless specifically qualified in writing by Vishay. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Looking for pricing, stock, or lifecycle information?

Click below to explore more details on WIN SOURCE:

 [View SF4005-TAP on WIN SOURCE](#)

 [Vishay Information](#)

Optimize Your Supply Chain with WIN SOURCE Solutions

-  Global Sourcing Solution
-  Obsolete Management
-  Cost Control Management
-  Shortage Management
-  Alternative Solution
-  Excess Inventory Management